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<b>Application Number</b>	09/745,402
<b>Filing Date</b>	December 21, 2000
<b>First Named Inventor</b>	Fleishman, R. et al
<b>Group Art Unit</b>	2834
<b>Examiner Name</b>	T. Lam
<b>Attorney Docket Number</b>	89.0426

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## U.S. PATENT DOCUMENTS

[illegible]

## FOREIGN PATENT DOCUMENTS

[illegible]

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